OKI semiconductor

MSM38128RS

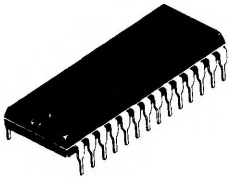
16384 WORD X 8 BIT MASK ROM

GENERAL DESCRIPTION

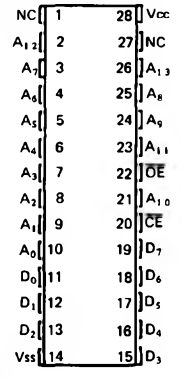
MSM38128RS is an N-channel silicon gate E/D MOS device ROM with a 16,384 word x 8 bit capacity. It operates on a 5V single power supply and the all inputs and outputs can be directly connected to the TTL. The adoption of an asynchronous system in the circuit requires no external clock assuring extremely easy operation. The availability of power down mode contributes to the low power dissipation which is as low as 20 mA (max) when the chip is not selected. The application of a byte system and the convertibility of the pins with a programmable ROM whose memory can be erased by ultraviolet ray radiation is most suitable for use as a large-capacity fixed memory for microcomputers and data terminals.
Since it provides both CE and OE signals, the connection of output terminals of other chips with the wired OR is possible ensuring an easy expand operation of memory and bus line control.

FEATURES

- 16384 words x 8 bits
- 5V single power supply
- Access time: 450 ns MAX
- Input/output TTL compatible
- 3-state output
- Power down mode
- 28-pin DIP



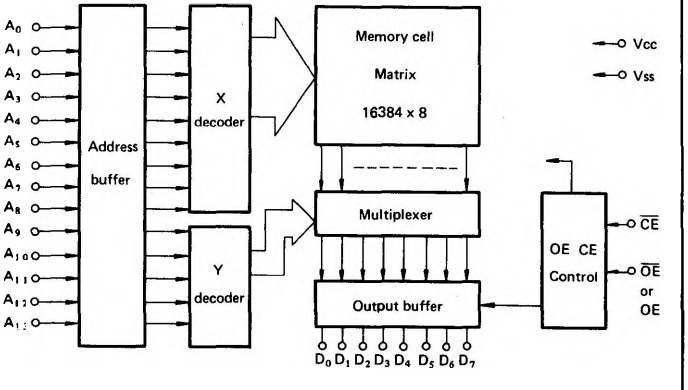
PIN CONFIGURATION



$\overline{OE}$	:	Output enable
Vcc, Vss	:	Power supply voltage
$A_0 \sim A_{13}$	:	Address input
$D_0 \sim D_7$	:	Data output
$\overline{CE}$	:	Chip enable

Note: The $\overline{OE}$ active level is specified by customer.

FUNCTIONAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

(Ta = 25°C)

Item	Symbol	Rating	Unit	Conditions
Power Supply Voltage	V_{CC}	−0.5 to 7	V	Respect to V_{SS}
Input Voltage	V_I	−0.5 to 7	V	
Output Voltage	V_O	−0.5 to 7	V	
Operating Temperature	T_{opr}	0 to 70	°C	
Storage Temperature	T_{stg}	−55 to 150	°C	

OPERATING CONDITION AND DC CHARACTERISTICS

Item	Symbol	Measuring Condition	Rating			Unit
			Min.	Typ.	Max.	
Power Supply Voltage	V_{CC}		4.5	5	5.5	V
	V_{SS}		0	0	0	V
Input Signal Level	V_{IH}		2	5	6	V
	V_{IL}		−0.5	0	0.8	V
Output Signal Level	V_{OH}	I_{OH} = −400 μA	2.4		V_{CC}	V
	V_{OL}	I_{OL} = 2.1 mA			0.4	V
Input Leak Current	I_{LI}	V_I = 0V or V_{CC}	−10		10	μA
Output Leak Current	I_{LO}	V_O = 0V or Vcc Chip not selected	−10		10	μA
Power Supply Current	Icc	Vcc = Max. I_O = 0 mA			120	mA
	Iccs	Vcc = Max.			20	mA
Peak Power ON Current	Ipo	Vcc = GND ~ Vcc Min. $\overline{CE}$ = Vco or V_{IH}			20	mA
Operating Temperature	T_{opr}		0		70	°C

AC CHARACTERISTICS

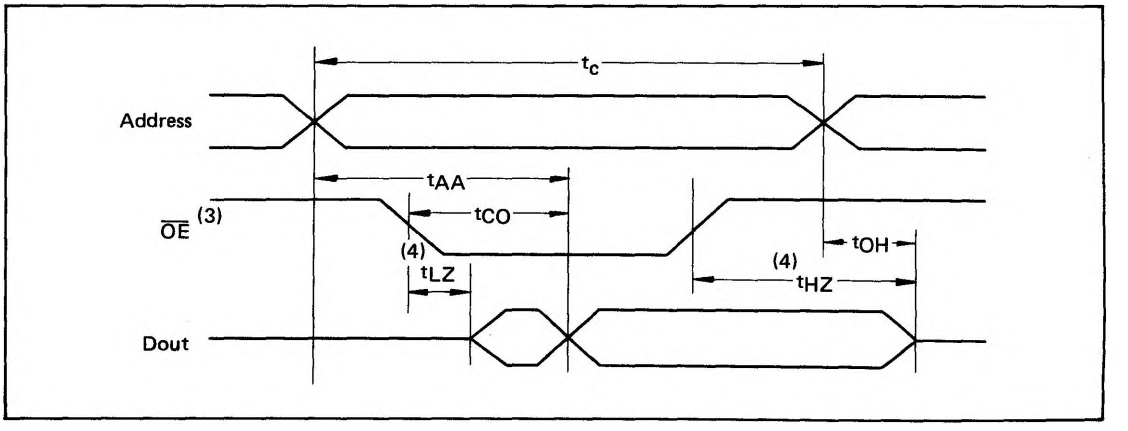
TIMING CONDITIONS

Item	Conditions
Input Signal Level	V_{IH}=2.0V V_{IL}=0.8V
Input Rising, Falling Time	tr=ty=15 ns
Timing Measuring Point Voltage	Input Voltage=1.5V
	Output Voltage=0.8 & 2.0V
Loading Condition	C_L=100 pF + 1 TTL

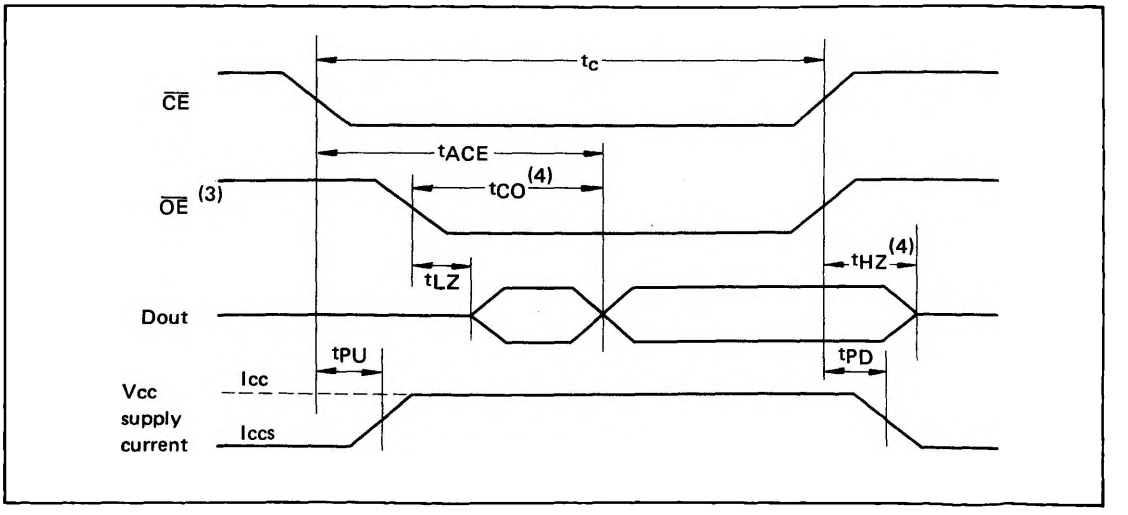
READ CYCLE

Item	Symbol	Specification Value			Unit	Remarks
		Min.	Typ.	Max.		
Cycle Time	t_c	450			ns	
Address Access Time	t_{AA}			450	ns	
Chip Enable Access Time	t_{ACE}			450	ns	
Output Delay Time	t_{CO}			150	ns	
Output Setting Time	t_{LZ}	20			ns	
Output Disable Time	t_{HZ}	0		120	ns	
Output Retaining Time	t_{OH}	20			ns	
Power Up Time	t_{PU}	0		120	ns	
Power Down Time	t_{PD}			120	ns	

1) READ CYCLE-1 (1)



2) READ CYCLE-2 (2)



Note: (1) $\overline{CE}$ is "L" level.
(2) The address is decided at the same time as or ahead of $\overline{CE}$ "L" level.
(3) $\overline{OE}$ is shown in the negative logic here, however the active level is freely selected.
(4) t_{CO} and t_{LZ} are determined by the later $\overline{CE}$ "L" or $\overline{OE}$ "L".
t_{HZ} is determined by the earlier $\overline{CE}$ "H" or $\overline{OE}$ "H".
t_{HZ} shows time until floating therefore it is not determined by the output level.

INPUT/OUTPUT CAPACITY

(Ta = 25°C, f = 1 MHz)

Item	Symbol	Specification Value		Unit	Remarks
		Min.	Max.		
Input Capacity	C_I		8	pF	V_I=0V
Output Capacity	C_O		10	pF	V_O=0V